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	9144030070855050X9		
	A1	A3	0755-33810388
	(Printed Circuit Board PCB) (High Density Interconnection HDI) (Flexible Printed Circuit FPC) (Rigid Printed Circuit Board 3C ISO9001 ISO14001 ISO14064 OHSAS18001 QC080000		

					1		
			/	mg/L		mg/L	
				61.5	83.59	280	
				13.54	18.38	40	
					1		
			/	mg/m3		mg/m3	
				1.04	6.15	7	
				1.21	7.2	30	
				0.25	1.46	30	
					4386.25		
					6238.91		
					19.99		
					69.56		
					144.12		

		529.81
		952.34
		67.59
		323.37
		7.98
		596.71
		69.99
		19.385
		3.18
		1.05
		7.19
		6.14
PMA		8.31
		239.22
		192.85
		1.63
		2.71
		5.33
		44.36

	Leq	Leq	Leq	Leq	
1	57.2	46.7	65	55	
1	59.1	48.6			
1	58.3	47.8			
1	59.5	49			

		2006 12	12000 /	
		2006 12	133.3 /	

()		2005-12-23	[2005] 213			
()		2009-09-08	[2009] 10091 7			

()					2007/ 7/19	[2007] 075
()					2009/ 2/9	[2009] 021
()					2011/4 /11	[2011] 026

			2014-3-10
1	"		
2	"		

	”
3	

	<p>http://www.epinfo.org</p> <p>2013 12 16 2015</p> <p> 2015 10 23</p>
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	1.	COD	pH			
	2.			2011	3	31
			2019	3		
	3.				500	RMB

1.

2. 2016 41

2017年1月19日